


| APPLICABLE STANDARD | | | | | | | | |
|--|-----------------------------|--|--|---|---|-------------------|--|--|
| RATING | OPERATING TEMPERATURE RANGE | -40 °C TO +105 °C (NOTE1) | STORAGE TEMPERATURE RANGE |  -10 °C TO +60 °C(NOTE2) | | | | |
| | CURRENT | 3 A | STORAGE HUMIDITY RANGE  | RELATIVE HUMIDITY 85% MAX (NOT DEWED) | | | | |
| | VOLTAGE | 250V AC | | | | | | |
| SPECIFICATIONS | | | | | | | | |
| ITEM | | TEST METHOD | | REQUIREMENTS | | QT AT | | |
| CONSTRUCTION | | | | | | | | |
| GENERAL EXAMINATION | | VISUALLY AND BY MEASURING INSTRUMENT. | | ACCORDING TO DRAWING. | | x x | | |
| MARKING | | CONFIRMED VISUALLY. | | | | x x | | |
| ELECTRIC CHARACTERISTICS | | | | | | | | |
| VOLTAGE DROP | | 12 V DC,1A DC. | | 30 mV/A MAX . | | x — | | |
| CONTACT RESISTANCE | | 20 mV AC , 1 mA AND 10 mA AC. | | 30 mΩ MAX . | | x — | | |
| MILLIVOLT LEVEL METHOD | | | | | | | | |
| INSULATION RESISTANCE | | 500 V DC FOR 30 sec. | | 100 MΩ MIN. | | x — | | |
| VOLTAGE PROOF | | 1000 V AC FOR 1 min. | | NO FLASHOVER OR BREAKDOWN. | | x — | | |
| MECHANICAL CHARACTERISTICS | | | | | | | | |
| MECHANICAL OPERATION | | 50 TIMES OF INSERTION AND EXTRACTION. | | ① CONTACT RESISTANCE MILLIVOLT LEVEL METHOD : 60 mΩ MAX. ② NO DAMAGE, CRACK AND DISTORTION OF PARTS. | | x — x — | | |
| VIBRATION | | FREQUENCY AT 20 TO 600 Hz, ACCELERATION AT 1.0~43.1 m/s ² FOR 3 h ON EACH 3 DIRECTIONS. | | ① NO ELECTRICAL DISCONTINUITY OF 7 Ω OR MORE FOR 1 μs. ② CONTACT RESISTANCE MILLIVOLT LEVEL METHOD : 60 mΩ MAX. ③ NO DAMAGE, CRACK AND DISTORTION OF PARTS. | | x — x — x — | | |
| SHOCK | | AFTER THE DRY HEAT TEST, APPLYING SHOCK 3 TIMES WITH ACCELERATION AT 981 m/s ² IN BOTH DIRECTIONS OF THE 3 AXES. | | ① NO ELECTRICAL DISCONTINUITY OF 7 Ω OR MORE FOR 1 μs. ② NO DAMAGE, CRACK AND DISTORTION OF PARTS. | | x — x — | | |
| LOCK STRENGTH | | PULL BACK IN THE MATING DIRECTION AND MEASURE THE FORCE AT THE MOMENT OF THE LOCK IS BROKEN. | | 100 N MIN. | | x — | | |
| ENVIRONMENTAL CHARACTERISTICS | | | | | | | | |
| DAMP HEAT | | EXPOSED AT 60 °C, 90 ~ 95 % RH FOR 96 h. | | ① CONTACT RESISTANCE MILLIVOLT LEVEL METHOD : 60 mΩ MAX. ② INSULATION RESISTANCE:100 MΩ MIN. ③ NO DAMAGE, CRACK AND DISTORTION OF PARTS. | | x — x — x — | | |
| THERMAL SHOCK | | TEMPERATURE- 40 → ROOM TEMP. →120 → ROOM TEMP. TIME 30 → 5 → 30 → 5 min UNDER 500 CYCLES. | | ① CONTACT RESISTANCE MILLIVOLT LEVEL METHOD : 60 mΩ MAX. ② NO DAMAGE, CRACK AND DISTORTION OF PARTS. | | x — x — | | |
| DRY HEAT | | EXPOSED AT 120 °C FOR 120 h. | | ① CONTACT RESISTANCE MILLIVOLT LEVEL METHOD : 60 mΩ MAX. ② NO DAMAGE, CRACK AND DISTORTION OF PARTS. | | x — x — | | |
| COLD | | EXPOSED AT -40°C FOR 120 h. | | ① CONTACT RESISTANCE MILLIVOLT LEVEL METHOD : 60 mΩ MAX. ② NO DAMAGE, CRACK AND DISTORTION OF PARTS. | | x — x — | | |
| RESISTANCE TO SO ₂ GAS | | EXPOSED AT 40 °C, 90 ~ 95 % RH, 10 ppm FOR 24 h. | | CONTACT RESISTANCE MILLIVOLT LEVEL METHOD : 60 mΩ MAX. | | x — | | |
| RESISTANCE TO SOLDERING HEAT | | SPECIFIED TEMPERATURE PROFILE FOR 2CYCLES. | | NO DEFORMATION OF CASE AND EXCESSIVE DISTORTION OF THE TERMINALS. | | x — | | |
| SOLDERABILITY | | SOLDERED AT SPECIFIED TEMPERATURE PROFILE. | | A NEW UNIFORM COATING OF SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSSED. | | x — | | |
| | COUNT | DESCRIPTION OF REVISIONS | DESIGNED | CHECKED | DATE | | | |
|  | 3 | DIS-T-00009122 | AN. SAIKI | HH. TSUKUMO | 20210413 | | | |
| REMARK (NOTE1) INCLUDE THE TEMPERATURE RISING BY CURRENT. (NOTE2) "STORAGE" means a long-term storage state for the unused product before assembly to PCB.  | | | | APPROVED | AR. SHIRAI | 20180416 | | |
| | | | | CHECKED | HS. OZAWA | 20180416 | | |
| | | | | DESIGNED | YT. HAYAKAWA | 20180416 | | |
| | | | | DRAWN | SK. HANAWA | 20180416 | | |
| Note QT: Qualification Test AT: Assurance Test X: Applicable Test | | | DRAWING NO. | | ELC-361159-10-00 | | | |
|  | SPECIFICATION SHEET | | PART NO. | GT25H2-32DP-2. 2H (10) | | | | |
| | HIROSE ELECTRIC CO., LTD. | | CODE NO. | CL0775-0086-6-10 |  | 1/1 | | |